
maXTouch 2911-node Touchscreen Controller Product Brief

Description

The mXT2912TD-AxUW 1.1 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The mXT2912TD-AxUW 1.1 allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

Automotive Applications

- AEC-Q100 Qualified
- CISPR 25 compliant (for both mutual and self capacitance measurements)

maXTouch® Adaptive Sensing Technology

- Microchip has patents related to the Ultrawide Touch technology. The touch sensor, which will be developed by the customer, its partners, and/or Microchip for Ultrawide touch programs, can only be part of a touch solution that incorporates a Microchip touchscreen controller to implement the relevant functionality.
- Single ultrawide touchscreen up to 20 X lines by 142 Y lines, made up of 40 X by 71 Y in a multiplexed arrangement (subject to configuration)
- Touchscreen size 34 inches (7:1 aspect ratio), assuming a sensor electrode pitch of 6 mm. Other sizes are possible with different electrode pitches and appropriate sensor material. Other sizes are possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 16 concurrent touches tracked in real time

Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 2 key arrays (subject to availability of X and Y lines and other configurations)
- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Touch Sensor Technology

- On-cell/touch-on display support including OLED and LCD (ITPS, IPS)
- Discrete/out-cell support including glass and PET film-based sensors
- Synchronization with display refresh timing capability

- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

Front Panel Material and Design

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner)
- 10 mm glass (or 5 mm PMMA) with bare finger (dependent on sensor size, touch size, configuration and stack-up)
- 6 mm glass (or 3 mm PMMA) with multi-finger 5 mm glove (2.7 mm PMMA equivalent) (dependent on sensor size, touch size, configuration and stack-up)
- Support for non-rectangular sensor designs (for example, circular, rounded or with cutouts)

Touch Performance

- Moisture/Water Compensation
 - No false touch with condensation or water drop up to 22 mm diameter
 - One-finger tracking with condensation or water drop up to 22 mm diameter
- Mutual capacitance and self capacitance measurements supported for robust touch detection
- P2P mutual capacitance measurements supported for extra sensitive multi-touch sensing
- Noise suppression technology to combat ambient and power-line noise
 - Up to 240 V_{PP} between 1 Hz and 1 kHz sinusoidal waveform (no touches)
 - Up to 20 V_{PP} between 1 kHz and 1 MHz sinusoidal waveform

- Burst Frequency
 - Flexible and dynamic Tx burst frequency selection to reduce EMC disturbance
 - Configurable Tx waveform shaping to reduce emissions
- Scan Speed
 - Typical report rate for 10 touches ≥ 80 Hz (subject to configuration)
 - Initial touch latency < 20 ms for first touch from idle (subject to configuration)
 - Configurable for power and speed optimization
- Touch panel failure detection
 - Automatic touch sensor diagnostics during run time to support the implementation of safety critical features
 - Diagnostics reported using dedicated output pin or by standard Object Protocol messages
 - Configurable test limits

On-chip Gestures

- Reports one-touch and two-touch gestures

Enhanced Algorithms

- Lens bending algorithms to remove display noise
- Touch suppression algorithms to remove unintentional large touches
- Palm Recovery Algorithm for quick restoration to normal state

Data Store

- 60-byte CRC checksummed data area for use as a run-time Product Data Store Area
- 64-byte data area for user's custom data (not CRC checksummed)

Power Saving

- Programmable timeout for automatic transition from Active to Idle state
- Pipelined analog sensing detection and digital processing to optimize system power efficiency

Power Supply

- Digital (Vdd) 3.3V nominal
- Digital I/O (VddIO) 3.3V nominal
- Analog (AVdd) 3.3V nominal
- High voltage external X line drive (XVdd) up to 8.5V

Application Interfaces

- Client interface for main communication with the device. Can be one of:
 - I²C interface, with support for Standard mode (up to 100 kHz), Fast mode (up to 400 kHz), Fast-mode Plus (up to 1 MHz)
 - SPI interface (up to 8 MHz)
- Interrupt to indicate when a message is available
- Additional SPI Debug Interface to read the raw data for tuning and debugging purposes

Package

- 176-lead LQFP 24 × 24 × 1.4 mm, 0.5 mm pitch

Operating Temperature

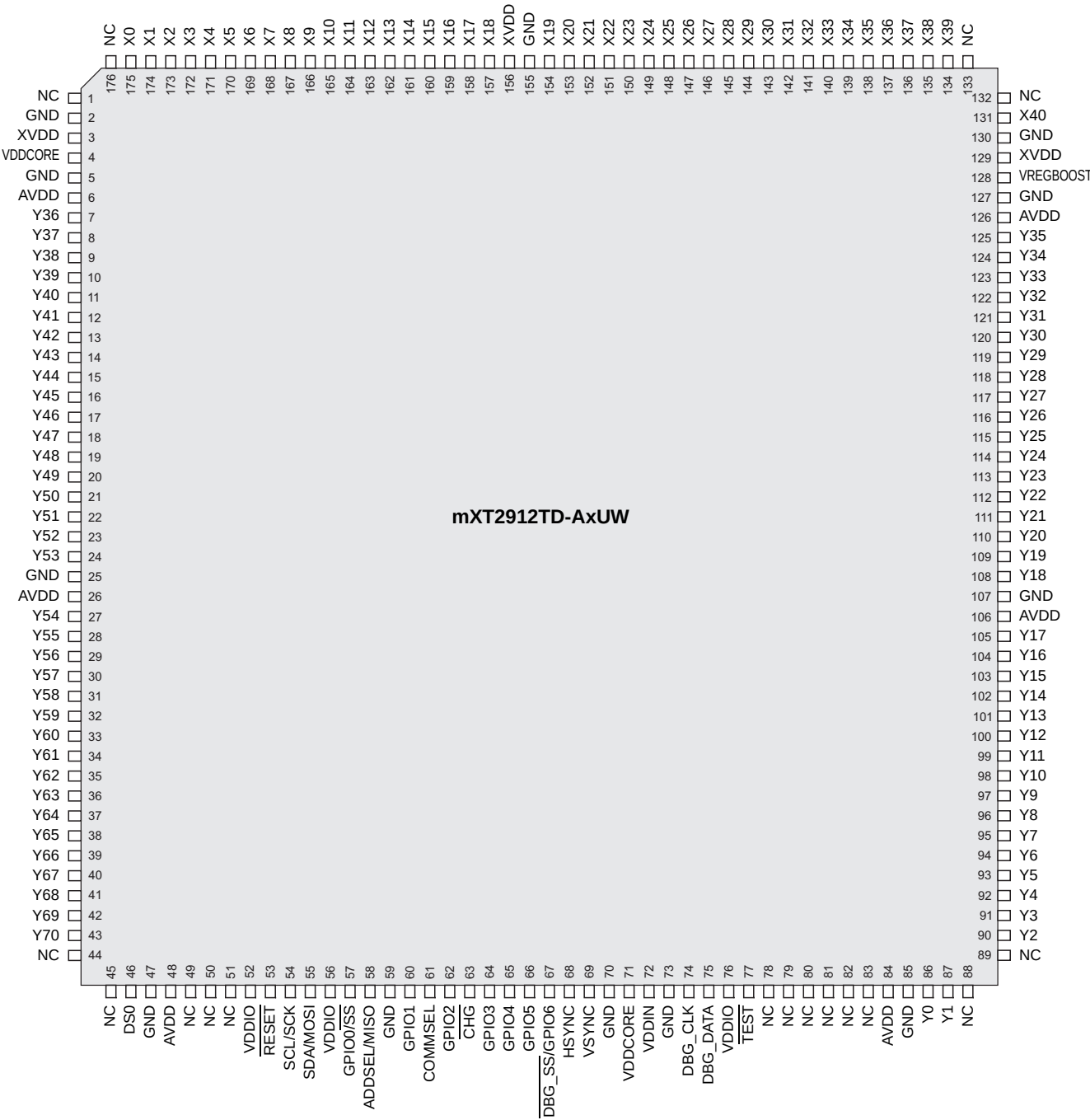
- ATMXT2912TD-ATUW: -40°C to $+85^{\circ}\text{C}$ (Grade 3)
- ATMXT2912TD-ABUW: -40°C to $+105^{\circ}\text{C}$ (Grade 2)

Design Services

- Review of device configuration, stack-up and sensor patterns

PIN CONFIGURATION

176-lead LQFP



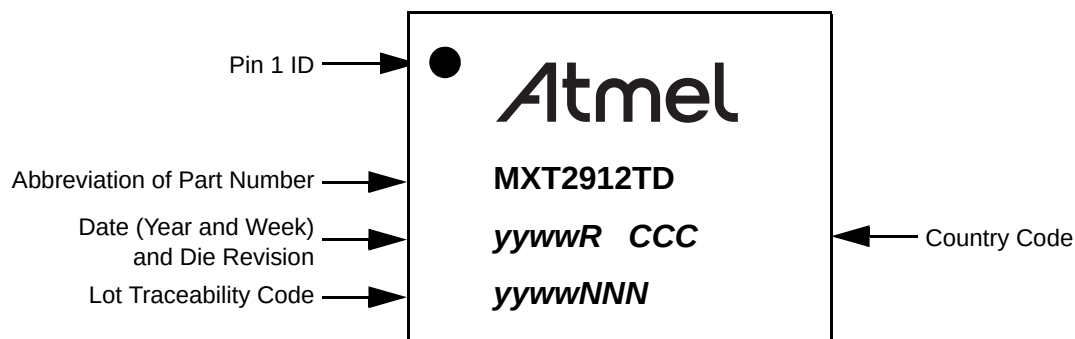
Top view

mXT2912TD-AxUW 1.1

1.0 PACKAGING INFORMATION

1.1 Package Marking Information

1.1.1 176-LEAD LQFP



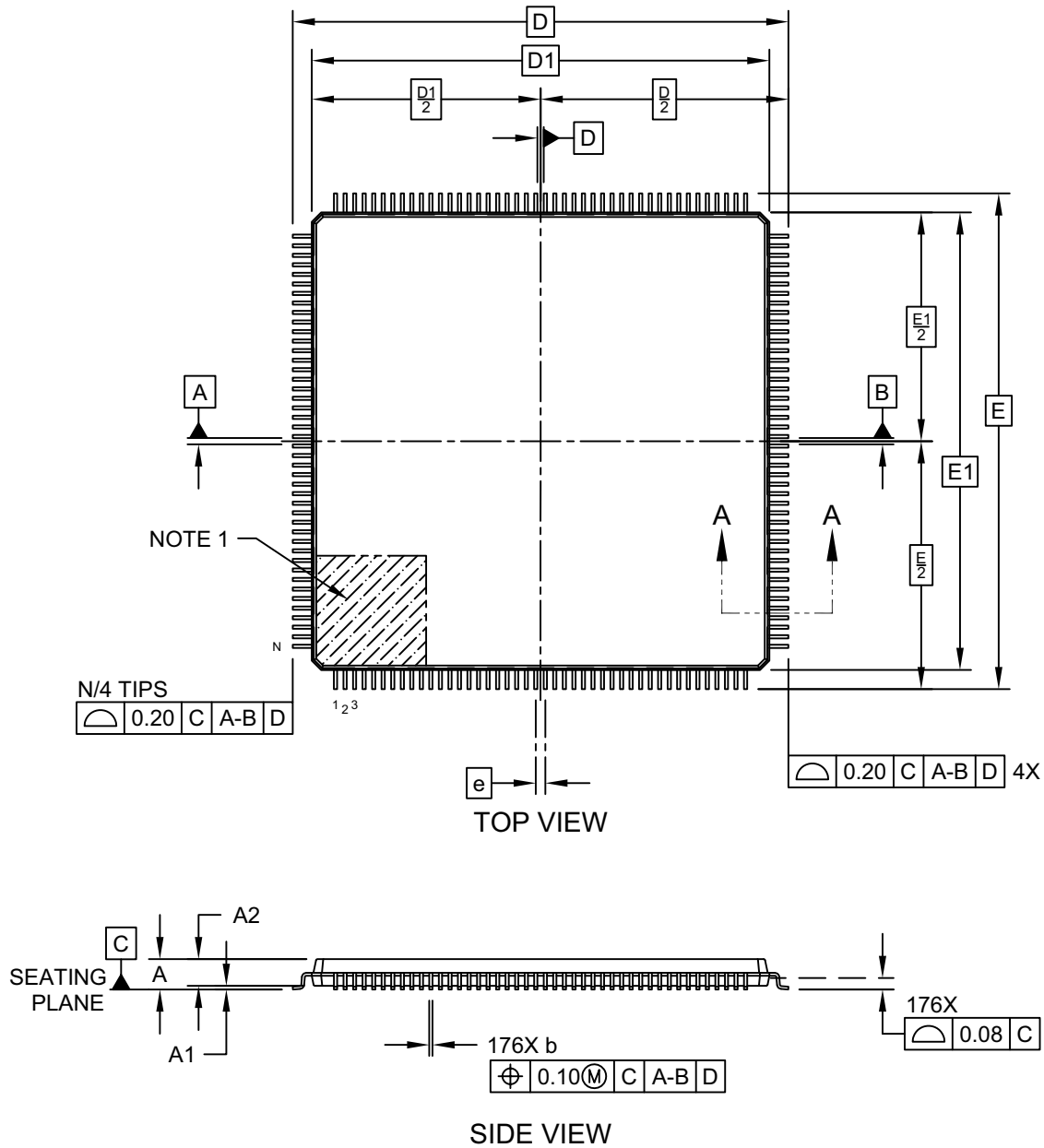
1.1.2 ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in [“Product Identification System” on page 9](#). That section also lists example part numbers for the device.

1.2 Package Details

176-Lead Plastic Quad Flatpack (2VB) - 24x24x1.4 mm Body [LQFP] Atmel Legacy Global Package Code AGR

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

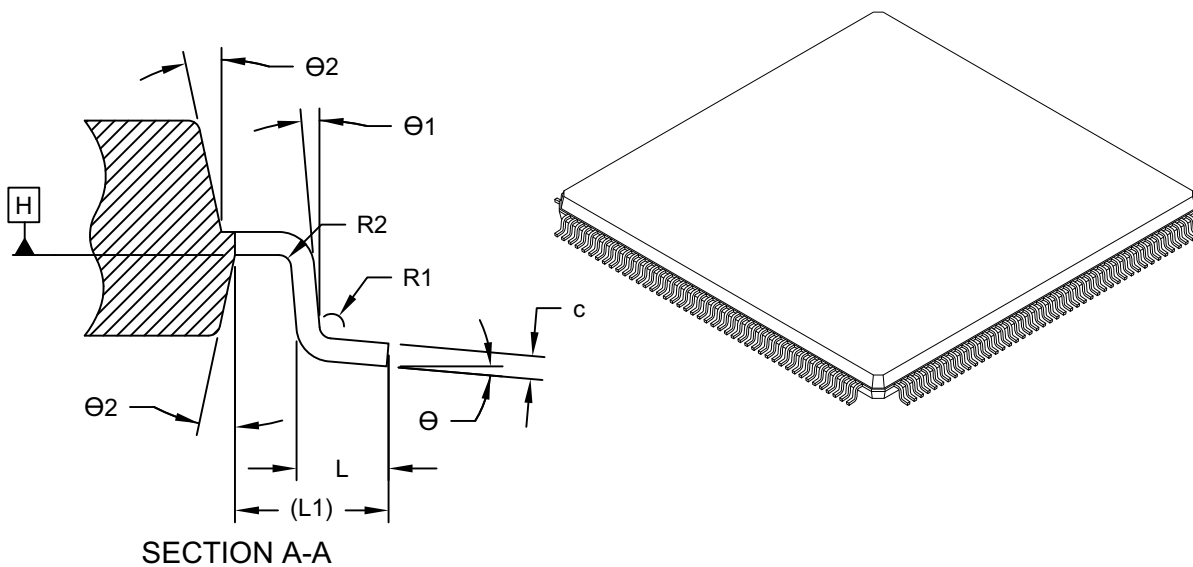


Microchip Technology Drawing C04-21013 Rev A Sheet 1 of 2

mXT2912TD-AxUW 1.1

176-Lead Plastic Quad Flatpack (2VB) - 24x24x1.4 mm Body [LQFP] Atmel Legacy Global Package Code AGR

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Terminals	N		176		
Pitch	e		0.50 BSC		
Overall Height	A		-	-	1.60
Standoff	A1		0.05	-	0.15
Molded Package Thickness	A2		1.35	1.40	1.45
Overall Length	D		26.00 BSC		
Molded Package Length	D1		24.00 BSC		
Overall Width	E		26.00 BSC		
Molded Package Width	E1		24.00 BSC		
Terminal Width	b		0.17	0.22	0.27
Terminal Thickness	c		0.09	-	0.20
Terminal Length	L		0.45	0.60	0.75
Footprint	L1		1.00 REF -		
Lead Bend Radius	R		0.08	-	-
Lead Bend Radius	R2		0.08	-	0.20
Foot Angle	Θ		0°	3.5°	7°
Lead Angle	Θ1		0°	-	-
Terminal-to-Exposed-Pad	Θ2		11°	12°	13°

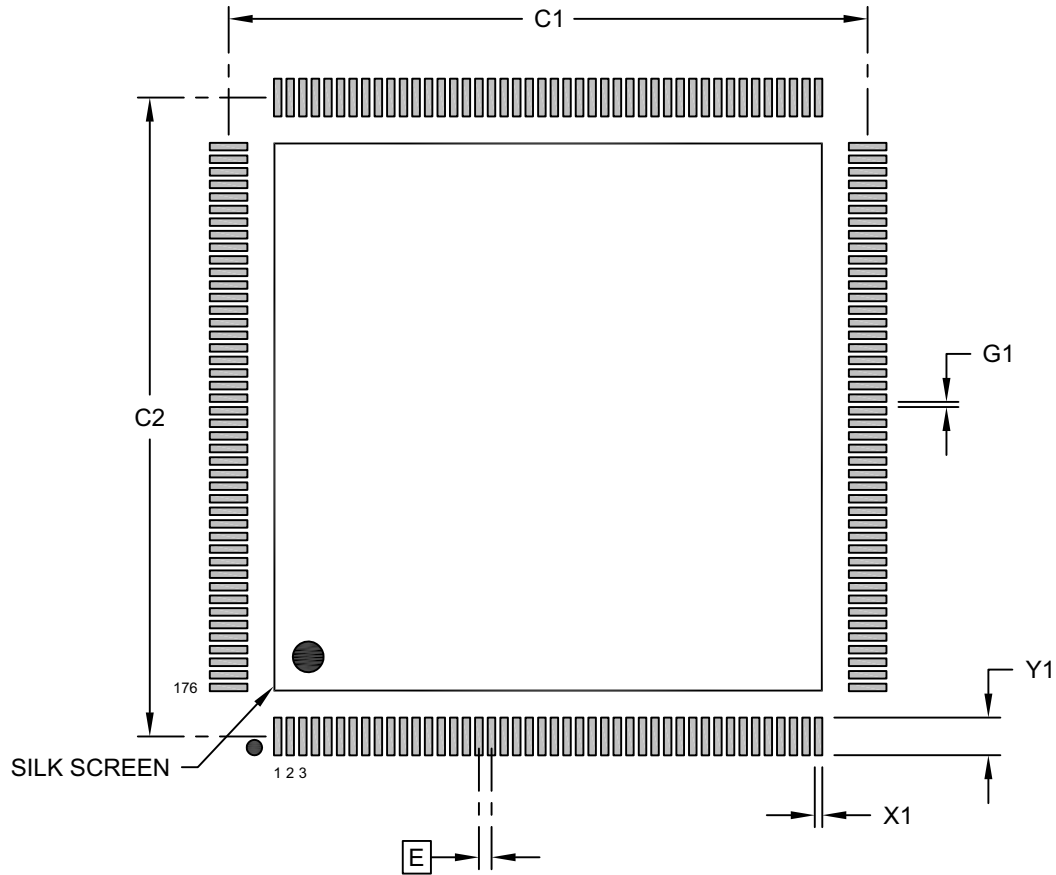
Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21013 Rev A Sheet 2 of 2

176-Lead Plastic Quad Flatpack (2VB) - 24x24x1.4 mm Body [LQFP]
Atmel Legacy Global Package Code AGR

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Contact Pad Spacing	C1		25.40	
Contact Pad Spacing	C2		25.40	
Contact Pad Width (X176)	X1			0.30
Contact Pad Length (X176)	Y1			1.50
Contact Pad to Center Pad (X172)	G1	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-23013 Rev A

APPENDIX A: REVISION HISTORY

Revision A (January 2023)

Initial edition for firmware revision 1.1.AA – Release

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See [“Orderable Part Numbers”](#) below for example part numbers for the mXT2912TD-AxUW.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>-XXX</u>	<u>[X]</u>	<u>[X]</u>	<u>[XXX]</u>
Device	Package	Temperature Range	Tape and Reel Option	Pattern

Device:	Base device name			
Package:	A	=	QFP (Plastic Quad Flatpack)	
	AM	=	VQFN (Plastic Very Thin Quad Flat No Lead)	
Temperature Range:	T	=	-40°C to +85°C (Grade 3)	
	B	=	-40°C to +105°C (Grade 2)	
Tape and Reel Option:	Blank	=	Standard Packaging (Tube or Tray)	
	R	=	Tape and Reel ⁽¹⁾	
Pattern:	Extension, QTP, SQTP, Code or Special Requirements (Blank Otherwise)			

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. See “[Orderable Part Numbers](#)” below or check with your Microchip Sales Office for package availability with the Tape and Reel option.

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Description
ATMXT2912TD-ATUWVA1 (Supplied in trays)	1.1.AA	176-lead LQFP 24 × 24 × 1.4 mm, RoHS compliant Operating temperature range -40°C to +85°C (Grade 3)
ATMXT2912TD-ATRUWVA1 (Supplied in tape and reel)		
ATMXT2912TD-ABUWVA1 (Supplied in trays)	1.1.AA	176-lead LQFP 24 × 24 × 1.4 mm, RoHS compliant Operating temperature range -40°C to +105°C (Grade 2)
ATMXT2912TD-ABRUWVA1 (Supplied in tape and reel)		

NOTES:

Note the following details of the code protection feature on Microchip products:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
 - Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
 - Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip products is strictly prohibited and may violate the Digital Millennium Copyright Act.
 - Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is “unbreakable”. Code protection is constantly evolving. Microchip is committed to continuously improving the code protection features of our products.
-

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at <https://www.microchip.com/en-us/support/design-help/client-support-services>.

THIS INFORMATION IS PROVIDED BY MICROCHIP “AS IS”. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP’S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION. Use of Microchip devices in life support and/or safety applications is entirely at the buyer’s risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPIC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maxStylus, maxTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, TrueTime, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, Clockstudio, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, GridTime, IdealBridge, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, IntelliMOS, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, KoD, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICKit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQL, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, Trusted Time, TSHARC, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2023, Microchip Technology Incorporated and its subsidiaries.

All Rights Reserved.

ISBN: 978-1-6683-1805-8

For information regarding Microchip’s Quality Management Systems, please visit www.microchip.com/quality.

Worldwide Sales and Service

AMERICAS

Corporate Office
 2355 West Chandler Blvd.
 Chandler, AZ 85224-6199
 Tel: 480-792-7200
 Fax: 480-792-7277
 Technical Support:
[http://www.microchip.com/
 support](http://www.microchip.com/support)
 Web Address:
www.microchip.com

Atlanta
 Duluth, GA
 Tel: 678-957-9614
 Fax: 678-957-1455

Austin, TX
 Tel: 512-257-3370

Boston
 Westborough, MA
 Tel: 774-760-0087
 Fax: 774-760-0088

Chicago
 Itasca, IL
 Tel: 630-285-0071
 Fax: 630-285-0075

Dallas
 Addison, TX
 Tel: 972-818-7423
 Fax: 972-818-2924

Detroit
 Novi, MI
 Tel: 248-848-4000

Houston, TX
 Tel: 281-894-5983

Indianapolis
 Noblesville, IN
 Tel: 317-773-8323
 Fax: 317-773-5453
 Tel: 317-536-2380

Los Angeles
 Mission Viejo, CA
 Tel: 949-462-9523
 Fax: 949-462-9608
 Tel: 951-273-7800

Raleigh, NC
 Tel: 919-844-7510

New York, NY
 Tel: 631-435-6000

San Jose, CA
 Tel: 408-735-9110
 Tel: 408-436-4270

Canada - Toronto
 Tel: 905-695-1980
 Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney
 Tel: 61-2-9868-6733

China - Beijing
 Tel: 86-10-8569-7000

China - Chengdu
 Tel: 86-28-8665-5511

China - Chongqing
 Tel: 86-23-8980-9588

China - Dongguan
 Tel: 86-769-8702-9880

China - Guangzhou
 Tel: 86-20-8755-8029

China - Hangzhou
 Tel: 86-571-8792-8115

China - Hong Kong SAR
 Tel: 852-2943-5100

China - Nanjing
 Tel: 86-25-8473-2460

China - Qingdao
 Tel: 86-532-8502-7355

China - Shanghai
 Tel: 86-21-3326-8000

China - Shenyang
 Tel: 86-24-2334-2829

China - Shenzhen
 Tel: 86-755-8864-2200

China - Suzhou
 Tel: 86-186-6233-1526

China - Wuhan
 Tel: 86-27-5980-5300

China - Xian
 Tel: 86-29-8833-7252

China - Xiamen
 Tel: 86-592-2388138

China - Zhuhai
 Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore
 Tel: 91-80-3090-4444

India - New Delhi
 Tel: 91-11-4160-8631

India - Pune
 Tel: 91-20-4121-0141

Japan - Osaka
 Tel: 81-6-6152-7160

Japan - Tokyo
 Tel: 81-3-6880- 3770

Korea - Daegu
 Tel: 82-53-744-4301

Korea - Seoul
 Tel: 82-2-554-7200

Malaysia - Kuala Lumpur
 Tel: 60-3-7651-7906

Malaysia - Penang
 Tel: 60-4-227-8870

Philippines - Manila
 Tel: 63-2-634-9065

Singapore
 Tel: 65-6334-8870

Taiwan - Hsin Chu
 Tel: 886-3-577-8366

Taiwan - Kaohsiung
 Tel: 886-7-213-7830

Taiwan - Taipei
 Tel: 886-2-2508-8600

Thailand - Bangkok
 Tel: 66-2-694-1351

Vietnam - Ho Chi Minh
 Tel: 84-28-5448-2100

EUROPE

Austria - Wels
 Tel: 43-7242-2244-39
 Fax: 43-7242-2244-393

Denmark - Copenhagen
 Tel: 45-4485-5910
 Fax: 45-4485-2829

Finland - Espoo
 Tel: 358-9-4520-820

France - Paris
 Tel: 33-1-69-53-63-20
 Fax: 33-1-69-30-90-79

Germany - Garching
 Tel: 49-8931-9700

Germany - Haan
 Tel: 49-2129-3766400

Germany - Heilbronn
 Tel: 49-7131-72400

Germany - Karlsruhe
 Tel: 49-721-625370

Germany - Munich
 Tel: 49-89-627-144-0
 Fax: 49-89-627-144-44

Germany - Rosenheim
 Tel: 49-8031-354-560

Israel - Ra'anana
 Tel: 972-9-744-7705

Italy - Milan
 Tel: 39-0331-742611
 Fax: 39-0331-466781

Italy - Padova
 Tel: 39-049-7625286

Netherlands - Drunen
 Tel: 31-416-690399
 Fax: 31-416-690340

Norway - Trondheim
 Tel: 47-7288-4388

Poland - Warsaw
 Tel: 48-22-3325737

Romania - Bucharest
 Tel: 40-21-407-87-50

Spain - Madrid
 Tel: 34-91-708-08-90
 Fax: 34-91-708-08-91

Sweden - Gothenberg
 Tel: 46-31-704-60-40

Sweden - Stockholm
 Tel: 46-8-5090-4654

UK - Wokingham
 Tel: 44-118-921-5800
 Fax: 44-118-921-5820